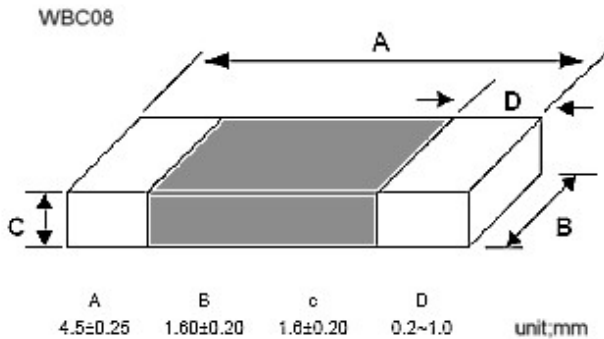




Multi Layer Chip Bead WBC08



Wilco Part Number	Impedance ohms	Tolerance %	Test Freq	DCR max ohms	Rated A mA max
WBC08-330-LF	33	25	100	0.20	600
WBC08-500-LF	50	25	100	0.20	600
WBC08-600-LF	60	25	100	0.20	600
WBC08-800-LF	80	25	100	0.20	600
WBC08-900-LF	90	25	100	0.30	500
WBC08-101-LF	100	25	100	0.30	500
WBC08-151-LF	150	25	100	0.30	500
WBC08-171-LF	170	25	100	0.30	500

Features

Effective EMI protection
Low DC resistance
High soldering heat resistance

Applications

Computers and Peripheral Equipment
VCRS, Television
Cellular Phones
Digital Communication Equipment
Various Electronics Equipments
Circuit Where a Stable Ground is Unavailable

Resistance to Soldering Heat

Pre-heating: 150 C, 1min
Solder Temperature: 260±5 C
Immersion Time: 10±1sec

Physical

Operating Temperature -55 C-125 C
Storage Temperature 25±3 C
Humidity < 80% RH
2000 per reel